Recyclability assessment *

Date: January 8, 2020 MR9

IRM	Power	Server	9040

Deserve	 	-			

nd name =	

Peripheral Component Interconnect express (PCIe)

Hybrid Serial Attached SCSI (SAS) cable

Memory Voltage Regulator Module (VRM)

IS Dual in-line memory modules (DIMM)

Input/output (I/O) and Standby VRM

IBM

9040 MR9

Mass (kg)

Qty

0.4 11

0.16

0.3

0.26

0.46

0.65

0.52

0 14

4.76

7.16

0.64

0.03 128

0.845

0.1

0.3

0.28

1.2

10.72

0.56

2.36

1.04

4.66

0.26

0.11

0.18

0.2

∑m(i) x RCR(i)/ mEEE x 100% = 97 %

* This recyclability assessment is based on the format in the International Electrotechnical Commission (IEC) 62635 Standard Guidelines for endof-life information provided by manufacturers and recyclers and for recyclability rate calculation of electrical and electronic equipment. Recyclability is defined by the standard to be "ability of waste product to be recycled, based on actual practices." The recyclability rate calculation equation is defined by this standard. Products were assessed based on the results of reuse, recycling, and/or disposal at IBM's

Product End-of-Life Management suppliers. The 2018 results for IBM product end-of-life management are attached to the right. The IBM and

management venders. Where there is a publically available recyclability rate for a commodity or assembly, such as those in the JRC Technical Report below, that rate is used. Where there is not a publically available recyclability rate, the overall rate of 97% was chosen because that is

the documented and actual recycling rates from IBM Product End of Life Management vendors. The 97% is the actual recyclability of IBM products as reported from IBM PELM vendors and the available infrastructure. According to NSF/ANSI 426-2018 - Printed circuit board

*** This POWER server is unique in content based on customer ordering. The weight will vary based on content of the server. The bill of material provided here is an example for this product and that which is used for the Installation Planning manual.

**** References: IEC/TR 62635, "Technical Report IEC/TR 62635. Guidelines for End of Life information provision from manufacturers and

recyclers, and for recyclability rate calculation of Electrical and Electronic Equipment." The International Electrotechnical Commission (IEC),

/ recoverability rates of electr(on)ic products August 2016; and NSF/ANSI 426 - 2018 Environmental Leadership and Corporate Social

P. Chancerel and M. Marwede, JRC Technical Reports, Feasibility study for setting-up reference values to support the calculation of recyclability

End of life treatment methodology - The methodology for recycling technologies and practices for this product generally follow the end-of-life

treatement process as outlined by IEC/TR62635. See the process flow diagram to the right. Disassembly of the product is required to sort into

recycling streams based on the infrastructure available to the dismantler. Generally circuit cards, backplanes, processors, etc. would go to a precious metal recycler. Metal covers, chassis, brackets, screws, etc to a metal smelter. Plastic parts such as the bezel, covers, etc. would go to a

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substrate material, included in printed circuit boards that will be sent to a smelter for metals recycling, shall be considered recyclable for the

** Assumptions - Recyclability rates projected for this product and parts are based on knowledge of the product material composition, publically available reference sources for recyclability of materials (see references below) and on the overall results of IBM's product end-of-life

the Environment 2018 Annual report is located at https://www.ibm.com/ibm/environment/annual/reporting.shtml

0.652

Product weight =

74.62 kg

4.4

0.16

1.2

1.04 0.64

0.46

0.65

2.08

0.28

4.76

7.16

1.28

3.84

3.38

0.4

0.28

4.8

10.72

0.56

2.36

4.16

4.66

2.08

0.18

1.2

74.62k

0.44

0.652

9.6

Mass/System(kg) Recyclability rate** Recyclable mass (kg)

97%

100%

100%

100%

100%

97%

97%

97%

97%

100%

97%

100%

100%

97%

93%

97%

97%

62%

97%

97%

97%

100%

90%

97%

92%

97%

97%

97%

WEEE

Pre-treat

Hazard mitigation

Partial or Full Dismantling

Remaining Parts

Mechanical Separation

Chemical Separation

ermal Separation (Smelting)

Material Separ

100%

4.27

0.16

1.04

0.64

0.45

0.63

2.02

0.27

4.76

6.95

1.28

9.6

3.72

3.14

0.39

1.16

0.17

4.66

10.4

0.54

2.36

3.74

0.652

4.52

1.91

0.43

0.18

1.16

Product end-of-life processing methods

Part requiring selective treatment

Part made of Single Recycluble Materials

Metal e.g. Fe,Cu,AL.

End-of-life treatment processes from IEC/TR 62635

Part Difficult to Process

47.6% Recycled

44.8% Resold

■ 2.9% Waste-to-Energy

Parts

Recycled Materials

Waste fo

Residue

0.7% Landfill or Incineration

= 4% Reused

72.40kg

Brand	i name =

Brand name =

Brand name =

Brand name =

Brand name =
Model name =

Brand name =

Brand name =

Brand	name =

Brand	name =

Brand	name =	

Brand name =	

Brand name =	

Brand name =

Circuit card with Cassette

Card with connectors

Circuit card with bus bars

Dual Chip Module (DCM)

CP Core Cache VRM Bezel

Chassis stiffening bar

Front drive sheetmetal assembly

Non-volatile Memory Express (NVMe) drives

RCR_{in} = Recycling rate of the ith part in the corresponding end-of-life treatment scenario

Hard disk drives (HDDs)

Recyclability rate: R =

Symbols and definitions m(i) = Mass of ith part

R rev = Recyclability rate mFFF = Total product mass

purpose of the calculation.

Responsibility Assessment of Servers

way modifies any agreements entered into by IBM.

2012:

plastic recycler

Stiffener for card

I/O card

Heatsink

Power supply

Chassis cover

Fan 92 mm

Circuit card

Operator panel

Lift Handles

Sum ***

Chassis

Brand name =
Model name =
Part/Sub-Assembly

Cassette

PCIe card

PCIe card

card PCIe card